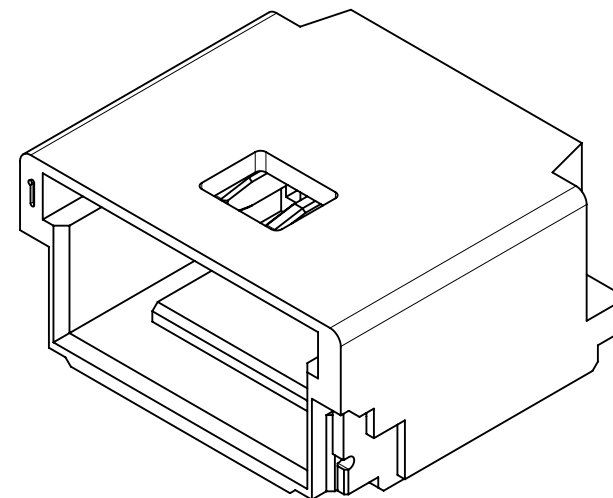
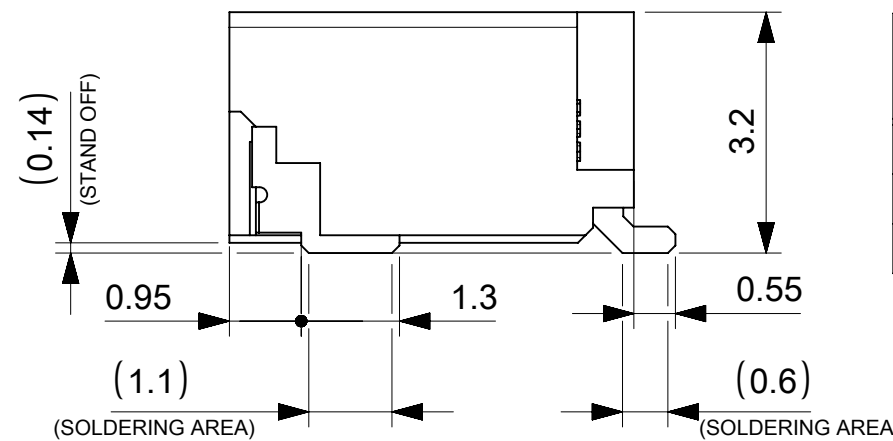


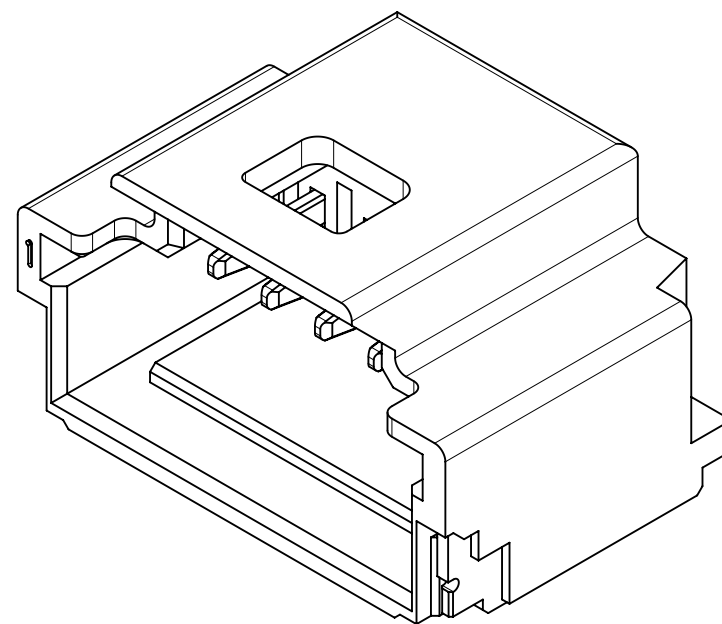
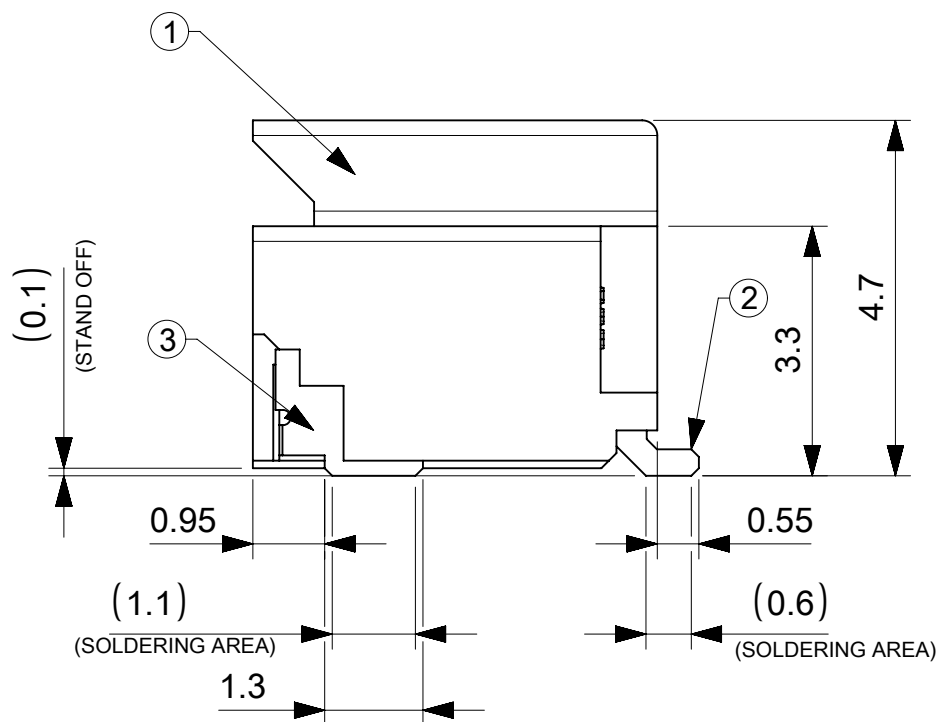
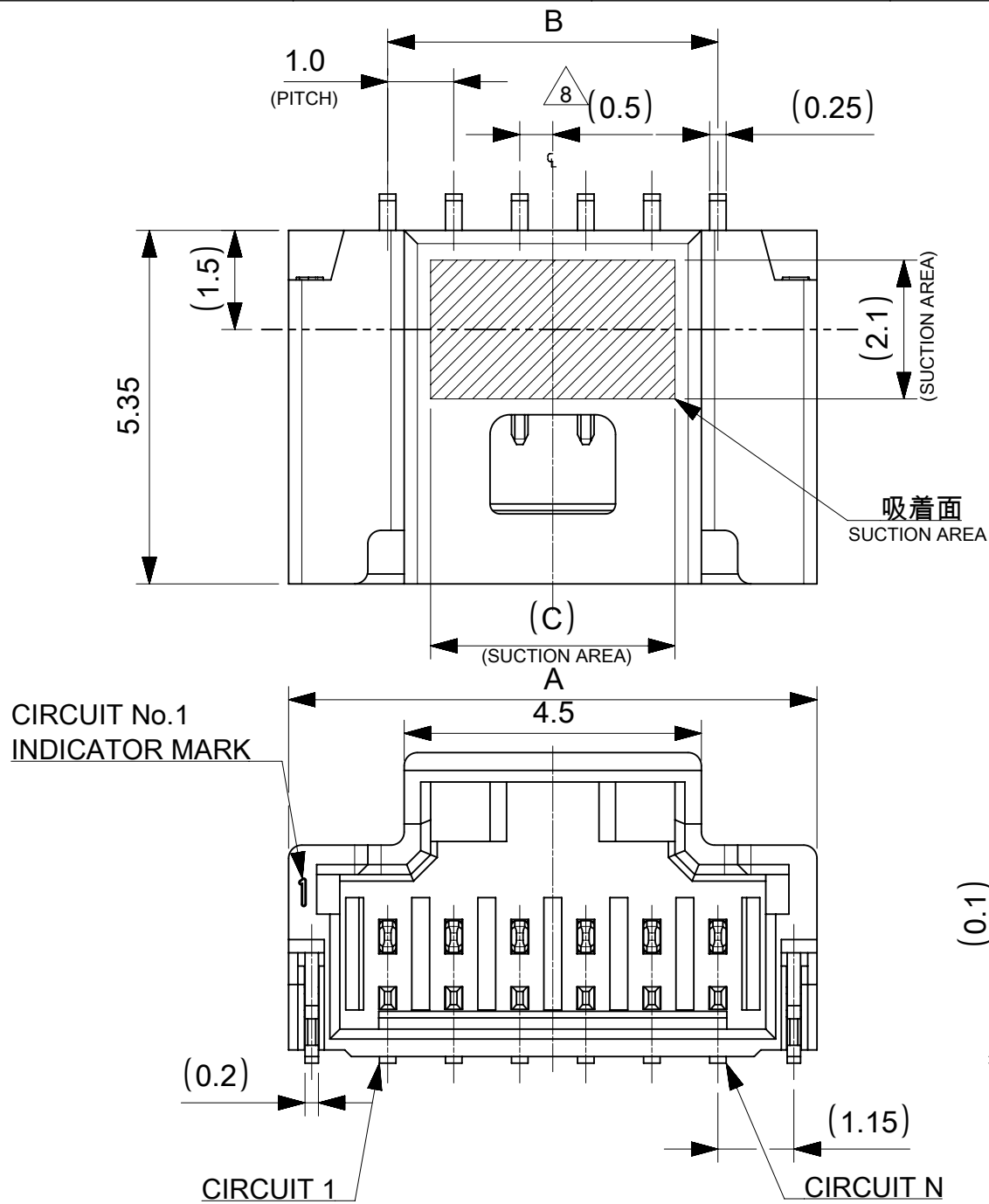
PLATING	PLATING THICKNESS [micro-meter MIN.]	SERIES No.	DRAWING No.
TIN	1.0	501568	5015680000-SD PSD 000
GOLD	0.1	202396	2023960000-SD PSD 000
	0.76	203559	2035590000-SD PSD 000



6.2	4.0	7.0	5
5.2	3.0	6.0	4
4.2	2.0	5.0	3
3.2	1.0	4.0	2
C	B	A	極数 CIRCUIT SIZE

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION									
DIMENSION UNITS		SCALE		CURRENT REV DESC:					
mm		NTS							
GENERAL TOLERANCES (UNLESS SPECIFIED)				PICO-CLASP 1.0 W/B SINGLE ROW RA SMT INNER LOCK GOLD PLATING 0.38 MICRO-METER					
ANGULAR TOL ± 3.0 °									
4 PLACES		± 0.2		EC NO: 614886		PRODUCT CUSTOMER DRAWING			
3 PLACES		± 0.2		DRWN: AISHIKAWA 2019/04/02					
2 PLACES		± 0.2		CHK'D: AIDA 2019/04/03		DOCUMENT NUMBER DOC TYPE DOC PART REVISION			
1 PLACE		± 0.2		APPR: KOMURAKAMI 2019/04/05					
0 PLACES		± 0.2		INITIAL REVISION:		2035580000-SD PSD 000 A			
				DRWN: AISHIKAWA 2019/04/02					
				APPR: KOMURAKAMI 2019/04/05		MATERIAL NUMBER CUSTOMER SHEET NUMBER			
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS				THIRD ANGLE PROJECTION		DRAWING		SERIES	
						A3-SIZE		203558	
						SEE SHEET 6		1 OF 6	

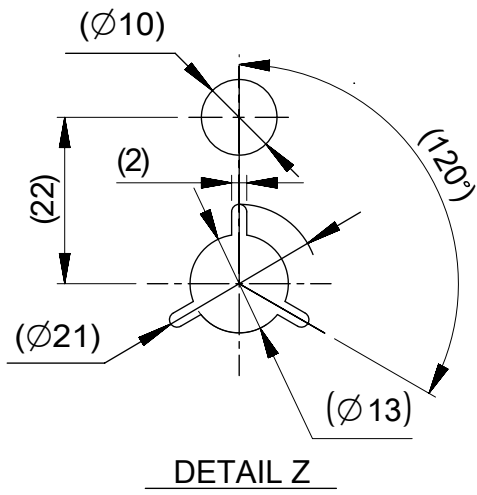
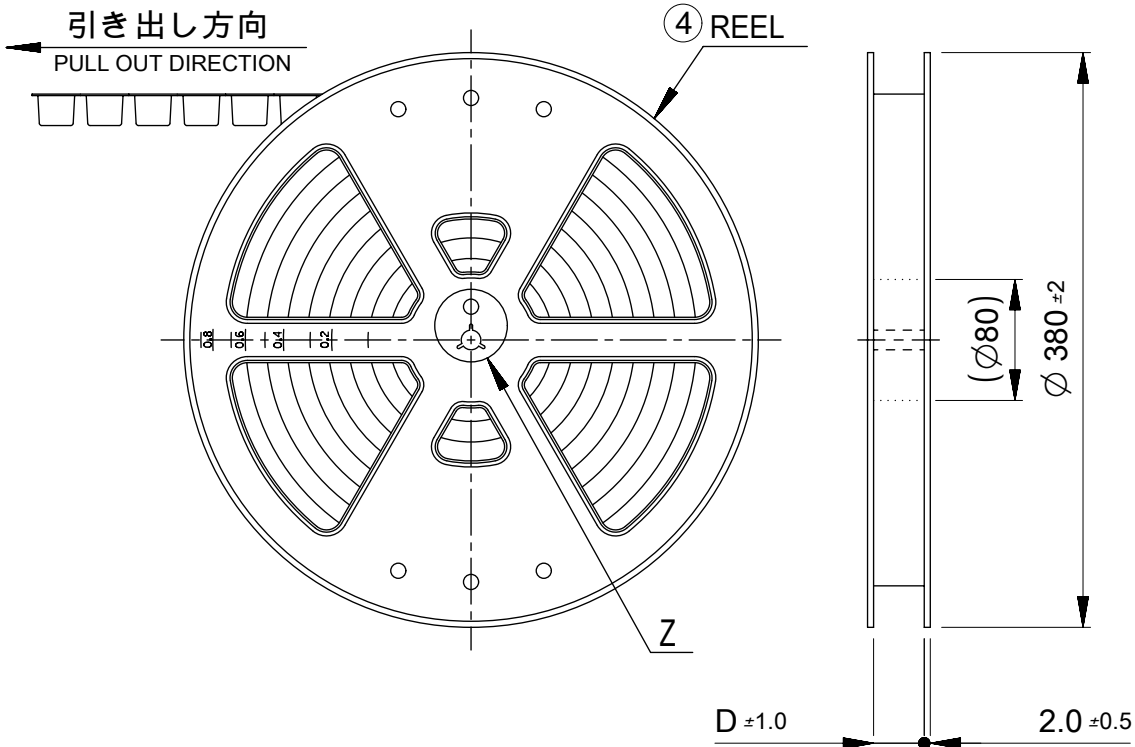
△ 2 TABLE 1					
番号 NO.	部品 PART	材質 MATERIAL			
①	ウエハー WAFER	ポリアミド(PA), UL94V-0, 色 : SEE SHEET 6 POLYAMIDE(PA), UL94V-0, COLOR : SEE SHEET 6			
②	ソルダーピン SOLDER PIN	リン青銅 PHOSPHOR BRONZE			
		接点部 CONTACT AREA	金めっき : 0.38 MICRO-METER MIN. GOLD PLATING		
		テール部 TAIL AREA	金めっき : 0.05 MICRO-METER MIN. GOLD PLATING		
		下地めっき UNDER PLATING	ニッケルめっき : 1.27 MICRO-METER MIN. NICKEL		
③	ネイル NAIL	黄銅 BRASS			
		テール部 TAIL AREA	錫めっき : 1.0 MICRO-METER MIN. MATTE TIN PLATING		
		下地めっき UNDER PLATING	ニッケルめっき : 1.0 MICRO-METER MIN. NICKEL		
DOCUMENT STATUS		P1	RELEASE DATE	2019/04/05	01:07:42



12.7	14.0	17.0	15
11.7	13.0	16.0	14
10.7	12.0	15.0	13
9.7	11.0	14.0	12
8.7	10.0	13.0	11
7.7	9.0	12.0	10
6.7	8.0	11.0	9
5.7	7.0	10.0	8
4.7	6.0	9.0	7
3.7	5.0	8.0	6
C	B	A	極数 CIRCUIT SIZE

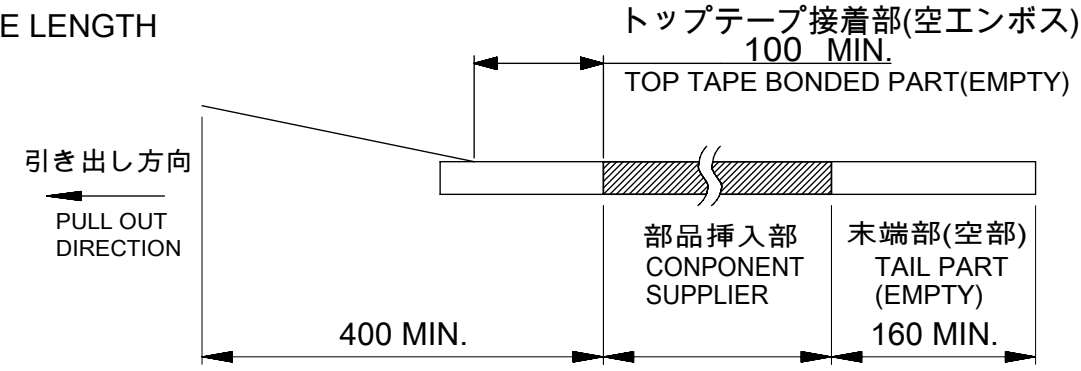
番号 NO.	部品 PART	材質 MATERIAL	
①	ウエハー WAFER	ポリアミド(PA), UL94V-0, 色 : SEE SHEET 6 POLYAMIDE(PA), UL94V-0, COLOR : SEE SHEET 6	
②	ソルダーピン SOLDER PIN	リン青銅 PHOSPHOR BRONZE	
		接点部 CONTACT AREA	金めっき : 0.38 MICRO-METER MIN. GOLD PLATING
		テール部 TAIL AREA	金めっき : 0.05 MICRO-METER MIN. GOLD PLATING
		下地めっき UNDER PLATING	ニッケルめっき : 1.27 MICRO-METER MIN. NICKEL
③	ネイル NAIL	黄銅 BRASS	
		テール部 TAIL AREA	錫めっき : 1.0 MICRO-METER MIN. MATTE TIN PLATING
		下地めっき UNDER PLATING	ニッケルめっき : 1.0 MICRO-METER MIN. NICKEL

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DIMENSION UNITS		SCALE		CURRENT REV DESC:			molex		
mm		NTS							
GENERAL TOLERANCES (UNLESS SPECIFIED)				EC NO: 614886 DRWN: AISHIKAWA CHK'D: AIDA APPR: KOMURAKAMI 2019/04/02 2019/04/03 2019/04/05			PICO-CLASP 1.0 W/B SINGLE ROW RA SMT INNER LOCK GOLD PLATING 0.38 MICRO-METER		
ANGULAR TOL ± 3.0 °									
4 PLACES ± 0.2				INITIAL REVISION:			DOCUMENT NUMBER 2035580000-SD		
3 PLACES ± 0.2									
2 PLACES ± 0.2				DRWN: AISHIKAWA APPR: KOMURAKAMI 2019/04/02 2019/04/05			DOC TYPE PSD		
1 PLACE ± 0.2									
0 PLACES ± 0.2				DOC PART 000			REVISION A		
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS									
THIRD ANGLE PROJECTION 		DRAWING A3-SIZE		SERIES 203558		MATERIAL NUMBER SEE SHEET 6		CUSTOMER SHEET NUMBER 2 OF 6	



NOTES

10. 梱包数量
2-5 CIRCUIT: 1700個/リール
6-15 CIRCUIT: 1300個/リール
NUMBER OF CONNECTORS
2-5 CIRCUIT : 1700 PIECES/REEL
6-15 CIRCUIT : 1300 PIECES/REEL
11. リードテープ長さ
LEAD TAPE LENGTH



12. トップテープの剥離強度はIEC60286-3に準拠。
TOP TAPE PEELING FORCE IS DEFINED BY IEC60286-3.
- △13 2~5極品は乾燥剤入り、ハイバリア梱包による納品となります。
2~5 CIRCUITS IS DELIVERED IN A HIGH BARRIER PACKAGE WITH DESOCCANT.
14. 梱包仕様書 : 2035589200 PS 200
PACKAGE SPECIFICATION:
- △15 発注番号 : SHEET 6 参照
ORDER No. : PLEASE REFER TO SHEET 6 FOR PRODUCT LIST.

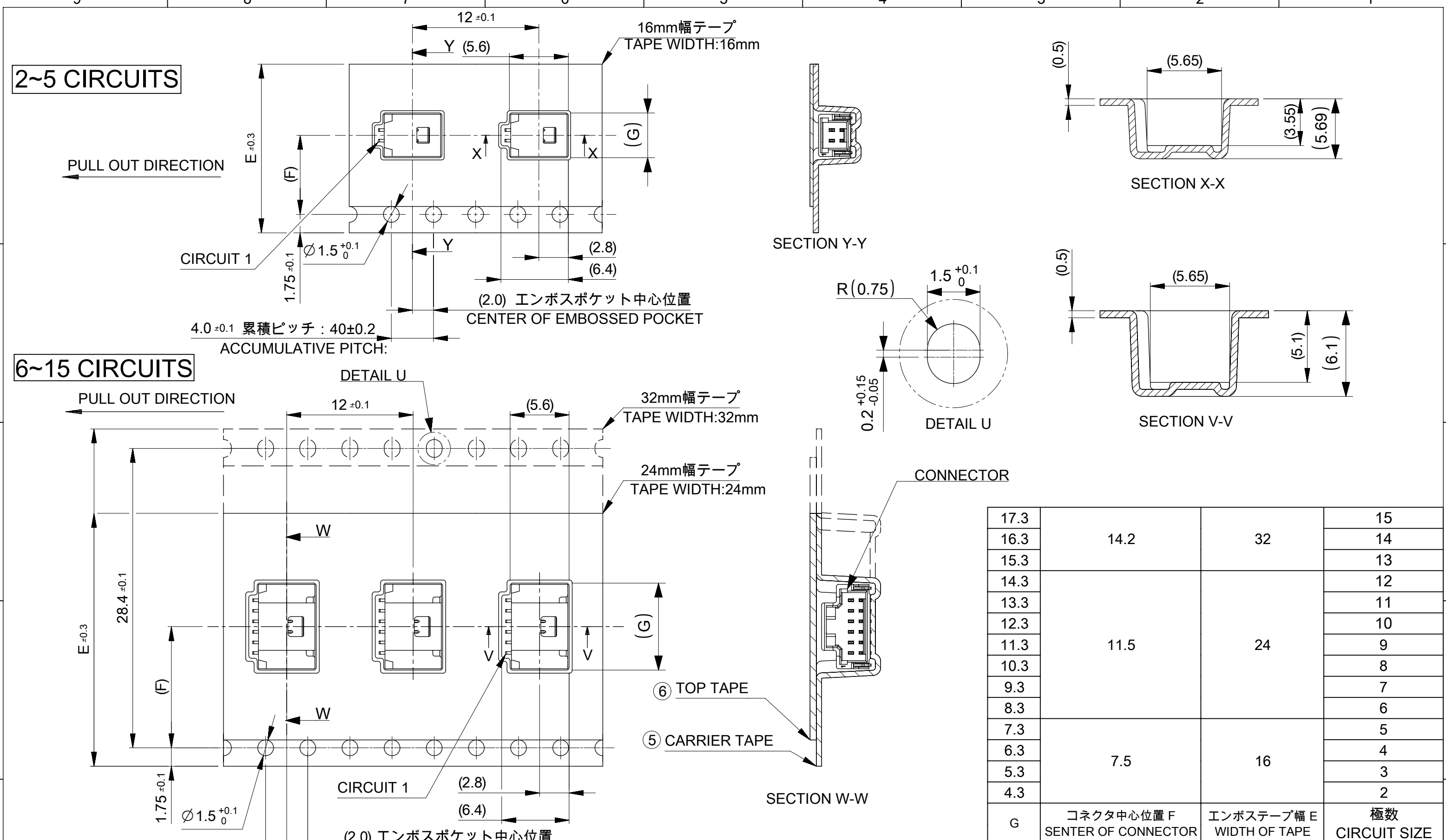
203558 - ** * *

極数 CIRCUIT SIZE	ハウジングカラー HOUSING COLOR	製品識別番号 IDENTIFICATION NUMBER
	0:NATURAL(BEIGE)	7:EMBOSSED PACKAGE

33.4	15
	14
	13
25.4	12
	11
	10
	9
	8
	7
17.5	6
	5
	4
	3
D	2
	極数 CIRCUIT SIZE

番号 NO.	部品 PART	材質 MATERIAL
④	リール REEL	ポリスチレン(PS) <リサイクル材を含む> POLYSTYRENE(PS) <RECYCLE MATERIAL CONTAINED>
DOCUMENT STATUS	P1	RELEASE DATE 2019/04/05 01:07:42

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		CURRENT REV DESC:		molex	
DIMENSION UNITS mm	SCALE NTS	EC NO: 614886 DRWN: AISHIKAWA 2019/04/02 CHK'D: AIDA 2019/04/03 APPR: KOMURAKAMI 2019/04/05		PICO-CLASP 1.0 W/B SINGLE ROW RA SMT INNER LOCK GOLD PLATING 0.38 MICRO-METER	
GENERAL TOLERANCES (UNLESS SPECIFIED)		INITIAL REVISION:		PRODUCT CUSTOMER DRAWING	
ANGULAR TOL ± 3.0 °		DRWN: AISHIKAWA 2019/04/02 APPR: KOMURAKAMI 2019/04/05		DOCUMENT NUMBER 2035580000-SD	
4 PLACES ± 0.2		THIRD ANGLE PROJECTION		DOC TYPE PSD	
3 PLACES ± 0.2		DRAWING A3-SIZE		DOC PART 000	
2 PLACES ± 0.2		SERIES 203558		REVISION A	
1 PLACE ± 0.2		MATERIAL NUMBER SEE SHEET 6		CUSTOMER	
0 PLACES ± 0.2		SHEET NUMBER 4 OF 6			
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS					



17.3	14.2	32	15
16.3			14
15.3			13
14.3	11.5	24	12
13.3			11
12.3			10
11.3			9
10.3			8
9.3	7.5	16	7
8.3			6
7.3			5
6.3			4
5.3			3
4.3			2
G	コネクタ中心位置 F SENER OF CONNECTOR	エンボステープ幅 E WIDTH OF TAPE	極数 CIRCUIT SIZE

番号 NO.	部品 PART	材質 MATERIAL
⑤	キャリアテープ CARRIER TAPE	ポリプロピレン(PP)、その他 POLYPROPYLEN(PP), etc
⑥	トップテープ TOP TAPE	ポリエチレン(PE)、その他 POLYETHYLENE(PE), etc

DOCUMENT STATUS	P1	RELEASE DATE	2019/04/05	01:07:42
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DIMENSION UNITS		SCALE		CURRENT REV DESC:			molex PICO-CLASP 1.0 W/B SINGLE ROW RA SMT INNER LOCK GOLD PLATING 0.38 MICRO-METER						
mm	NTS												
GENERAL TOLERANCES (UNLESS SPECIFIED)													
ANGULAR TOL ± 3.0 °				EC NO: 614886			PRODUCT CUSTOMER DRAWING						
4 PLACES		±	0.2	DRWN: AISHIKAWA 2019/04/02									
3 PLACES		±	0.2	CHK'D: AIDA 2019/04/03									
2 PLACES		±	0.2	APPR: KOMURAKAMI 2019/04/05		DOCUMENT NUMBER 2035580000-SD							
1 PLACE		±	0.2	INITIAL REVISION:						DOC TYPE		DOC PART	REVISION
0 PLACES		±	0.2	DRWN: AISHIKAWA 2019/04/02						PSD		000	A
APPR: KOMURAKAMI 2019/04/05													
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS				THIRD ANGLE PROJECTION		DRAWING		SERIES		MATERIAL NUMBER	CUSTOMER	SHEET NUMBER	
						A3-SIZE		203558		SEE SHEET 6			

△13△15製品一覧 PRODUCT LIST

HOUSING COLOR	
NATURAL(BEIGE)	
203558 1507	15
△13 1407	14
1307	13
1207	12
1107	11
1007	10
0907	9
0807	8
0707	7
0607	6
0507	5
0407	4
▽ 0307	3
203558 0207	2
発注番号 ORDER No.	
梱包形態：エンボスリール PACKAGE:EMBOSSED REEL	極数 CIRCUIT SIZE

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DIMENSION UNITS	SCALE	CURRENT REV DESC:					
mm	NTS	EC NO: 614886 DRWN: AISHIKAWA 2019/04/02 CHK'D: AIDA 2019/04/03 APPR: KOMURAKAMI 2019/04/05 INITIAL REVISION: DRWN: AISHIKAWA 2019/04/02 APPR: KOMURAKAMI 2019/04/05					
GENERAL TOLERANCES (UNLESS SPECIFIED)							
ANGULAR TOL	± 3.0 °						
4 PLACES	± 0.2						
3 PLACES	± 0.2						
2 PLACES	± 0.2	PRODUCT CUSTOMER DRAWING					
1 PLACE	± 0.2	DOCUMENT NUMBER		DOC TYPE	DOC PART	REVISION	
0 PLACES	± 0.2	2035580000-SD		PSD	000	A	
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIRD ANGLE PROJECTION	DRAWING	SERIES	MATERIAL NUMBER	CUSTOMER	SHEET NUMBER
			A3-SIZE	203558	SEE SHEET 6		6 OF 6

molex

PICO-CLASP 1.0 W/B
SINGLE ROW RA SMT INNER LOCK GOLD PLATING
0.38 MICRO-METER